

NC7SZ18

TinyLogic® UHS 1-of-2 Non-Inverting De-multiplexer with 3-STATE Deselected Output

Features

- Ultra-High Speed: t_{PD} 2.5ns Typical at 5V V_{CC}
- High Impedance Output when Deselected
- Broad V_{CC} Operating Range: 1.65V to 5.50V
- Power Down High Impedance Inputs/Outputs
- Over-Voltage Tolerance Inputs Facilitate 5V to 3V Translation
- Proprietary Noise/EMI Reduction Circuitry
- Ultra-Small MicroPak™ Packages

Description

The NC7SZ18 is a 1-of-2 non-inverting demultiplexer. The device will buffer the data on the A pin and pass to either output Y_0 or Y_1 dependent on whether state of the select pin (S) is LOW or HIGH respectively. The deselected output will be placed into a high impedance state. The device is fabricated with advanced CMOS technology to achieve ultra high speed with high output drive while maintaining low static power dissipation over a broad V_{CC} operating range. The device is specified to operate over the 1.65V to 5.5V V_{CC} operating range. The inputs and outputs are high impedance when V_{CC} is 0V. Inputs tolerate voltages up to 5.5V independent of V_{CC} operating range.

Ordering Information

Part Number	Top Mark	Package	Packing Method
NC7SZ18P6X	Z18	6-Lead SC70, EIAJ SC88 1.25mm Wide	3000 Units on Tape & Reel
NC7SZ18L6X	D5	6-Lead MicroPak™, 1.00mm Wide	5000 Units on Tape & Reel
NC7SZ18FHX	D5	6-Lead, MicroPak2™, 1x1mm Body, .35mm Pitch	5000 Units on Tape & Reel

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MicroPak™ is a trademark of Fairchild Semiconductor Corporation.

Pin Configurations

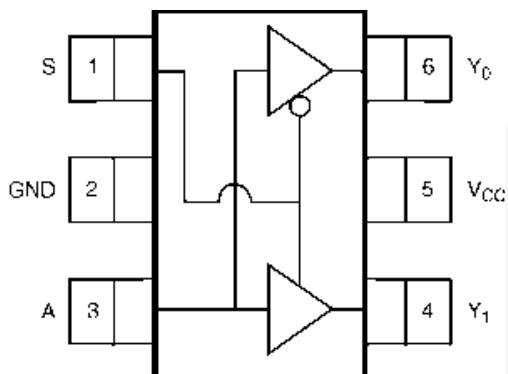


Figure 1. SC70 (Top View)

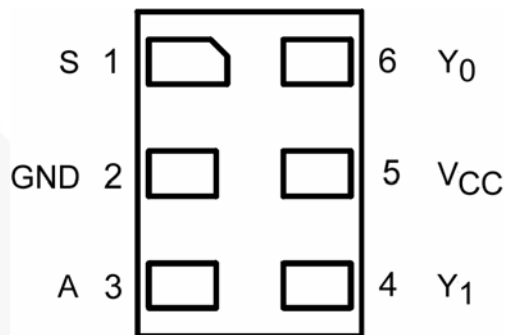


Figure 2. MicroPak™ (Top Through View)

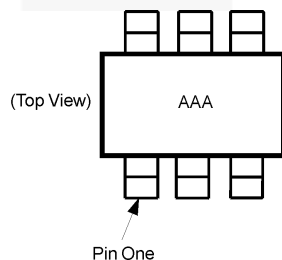


Figure 3. Pin 1 Orientation

Notes:

1. AAA represents product code top mark (see *Ordering Information*).
2. Orientation of top mark determines pin one location.
3. Reading the top mark left to right, pin one is the lower left pin.

Pin Definitions

Pin # SC70	Pin # MicroPak™	Name	Description
1	1	S	Data Input
2	2	GND	Ground
3	3	A	Demultiplexer Data
4	4	Y ₁	Output
5	5	V _{CC}	Supply Voltage
6	6	Y ₀	Output

Function Table

Inputs		Output	
S	A	Y ₀	Y ₁
L	L	L	Z
L	H	H	Z
H	L	Z	L
H	H	Z	H

H = HIGH Logic Level

L = LOW Logic Level

X = 3-STATE

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter		Min.	Max.	Unit
V_{CC}	Supply Voltage		-0.5	7.0	V
V_{IN}	DC Input Voltage		-0.5	7.0	V
V_{OUT}	DC Output Voltage		-0.5	7.0	V
I_{IK}	DC Input Diode Current	$V_{IN} \leq -0.5V$		-50	mA
I_{OK}	DC Output Diode Current	$V_{IN} \leq -0.5V$		-50	mA
I_{OUT}	DC Output Current			± 50	mA
I_{CC} or I_{GND}	DC V_{CC} or Ground Current			± 100	mA
T_{STG}	Storage Temperature Range		-65	+150	°C
T_J	Junction Temperature Under Bias			+150	°C
T_L	Junction Lead Temperature (Soldering, 10 Seconds)			+260	°C
P_D	Power Dissipation at +85°C	SC70-6		180	mW
		MicroPak™-6		130	
		MicroPak2™-6		120	
ESD	Human Body Model, JEDEC:JESD22-A114			4000	V
	Charge Device Model, JEDEC:JESD22-C101			2000	

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Conditions	Min.	Max.	Unit
V_{CC}	Supply Voltage Operating		1.65	5.50	V
	Supply Voltage Data Retention		1.5	5.5	
V_{IN}	Input Voltage		0	5.5	V
V_{OUT}	Output Voltage		0	V_{CC}	V
t_r, t_f	Input Rise and Fall Times	V_{CC} at 1.8V, $\pm 0.15V$, 2.5V $\pm 0.2V$	0	20	ns/V
		V_{CC} at 3.3V $\pm 0.3V$	0	10	
		V_{CC} at 5.0V $\pm 0.5V$	0	5	
T_A	Operating Temperature		-40	+85	°C
θ_{JA}	Thermal Resistance	SC70-6		425	°C/W
		MicroPak™-6		500	
		MicroPak2™-6		560	

DC Electrical Characteristics

Symbol	Parameter	V _{CC}	Condition	T _A =+25°C			T _A =-40 to +85°C		Unit	
				Min.	Typ.	Max.	Min.	Max.		
V _{IH}	HIGH Level Input Voltage	1.65 to 1.95		0.75V _{CC}			0.75V _{CC}		V	
		2.30 to 5.50		0.70V _{CC}			0.70V _{CC}			
V _{IL}	LOW Level Input Voltage	1.65 to 1.95				0.25V _{CC}		0.25V _{CC}	V	
		2.30 to 5.50				0.30V _{CC}		0.30V _{CC}		
V _{OH}	HIGH Level Output Voltage	1.65	V _{IN} =V _{IH} , I _{OH} =-100μA	1.55	1.65		1.55		V	
		2.30		2.20	2.30		2.20			
		3.00		2.90	3.00		2.90			
		4.50		4.40	4.50		4.40			
		1.65	I _{OH} =-4mA	1.29	1.52		1.29			
		2.30		1.90	2.15		1.90			
		3.00		2.40	2.80		2.40			
		3.00		2.30	3.68		2.30			
4.50	I _{OH} =-32mA	3.80	4.20		3.80					
V _{OL}	LOW Level Output Voltage	1.65	V _{IN} =V _{IL} , I _{OL} =100μA		0.00	0.10		0.10	V	
		2.30			0.00	0.10		0.10		
		3.00			0.00	0.10		0.10		
		4.50			0.00	0.10		0.10		
		1.65	I _{OL} =4mA		0.08	0.24		0.24		
		2.30		I _{OL} =8mA		0.10	0.30			0.30
		3.00		I _{OL} =16mA		0.15	0.40			0.40
		3.00		I _{OL} =24mA		0.22	0.55			0.55
		4.50		I _{OL} =32mA		0.22	0.55			0.55
I _{IN}	Input Leakage Current	0 to 5.5	V _{IN} =5.5V, GND			±0.1		±1.0	μA	
I _{OZ}	3-STATE Output Leakage	1.65 to 5.50	V _{IN} =V _{IL} or V _{OH} 0<V _{OUT} ≤5.5V			±0.5		±5.0	μA	
I _{OFF}	Power Off Leakage Current	0	V _{IN} or V _{OUT} =5.5V			1		10	μA	
I _{CC}	Quiescent Supply Current	1.65 to 5.50	V _{IN} =5.5V, GND			1		10	μA	

AC Electrical Characteristics

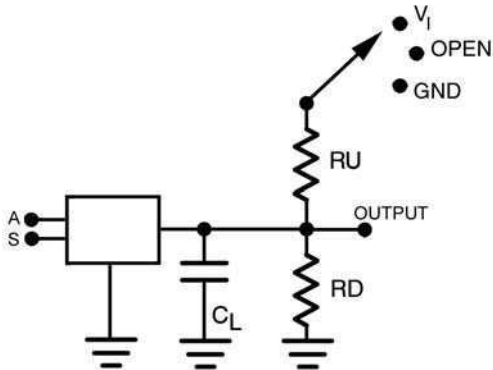
Symbol	Parameter	V _{CC}	Condition	T _A =+25°C			T _A =-40 to +85°C		Unit	Figure
				Min.	Typ.	Max.	Min.	Max.		
t _{PLH} , t _{PHL}	Propagation Delay A to Y ₀ or Y ₁	1.80 ± 0.15	C _L =15pF, R _D =1MΩ, V ₁ =OPEN	2.0	6.3	10.1	2.0	10.5	ns	Figure 4 Figure 6
		2.50 ± 0.20		1.0	3.6	5.7	1.0	6.0		
		3.30 ± 0.30		0.8	2.7	4.0	0.8	4.3		
		5.00 ± 0.50		0.5	2.0	3.1	0.5	3.3		
		3.30 ± 0.30	C _L =50pF, R _D =500Ω, V ₁ =OPEN	1.2	3.4	4.9	1.2	5.4		
		5.00 ± 0.50		0.8	2.5	3.9	0.8	4.2		
t _{PZL} , t _{PHZ}	Output Enable Time	1.80 ± 0.15	C _L =50pF, R _D ,R _U =500Ω, V ₁ =GND for t _{PZH} V ₁ =V _{IN} for t _{PZL} V _{IN} =2 x V _{CC}	3.0	6.9	12.0	3.0	12.5	ns	Figure 4 Figure 6
		2.50 ± 0.20		1.8	4.2	6.8	1.8	7.3		
		3.30 ± 0.30		1.2	3.2	5.0	1.2	5.5		
		5.00 ± 0.50		0.8	2.5	4.0	0.8	4.3		
	Output Disable Time	1.80 ± 0.15	C _L =50pF, R _D ,R _U =500Ω, V ₁ =GND for t _{PHZ} V ₁ =V _{IN} for t _{PLZ} V _{IN} =2 x V _{CC}	2.5	6.0	10.0	2.5	10.5	ns	Figure 4 Figure 6
		2.50 ± 0.20		1.5	4.0	6.8	1.5	7.1		
		3.30 ± 0.30		0.8	2.9	4.9	0.8	5.3		
		5.00 ± 0.50		0.3	1.8	3.5	0.3	3.7		
C _{IN}	Input Capacitance	0			2.5				pF	
C _{OUT}	Output Capacitance	0			4.0				pF	
C _{PD}	Power Dissipation Capacitance ⁽⁴⁾	3.30			16.0				pF	Figure 5
		5.00			19.5					

Note:

- C_{PD} is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current consumption (I_{CCD}) at no output loading and operating at 50% duty cycle. C_{PD} is related to I_{CCD} dynamic operating current by the expression: I_{CCD}=(C_{PD})(V_{CC})(f_{IN})+(I_{CC}static).



AC Loadings and Waveforms



Notes:

- 5. C_L includes load and stray capacitance.
- 6. Input PRR = 1.0MHz, $t_W = 500\text{ns}$.

Figure 4. AC Test Circuit

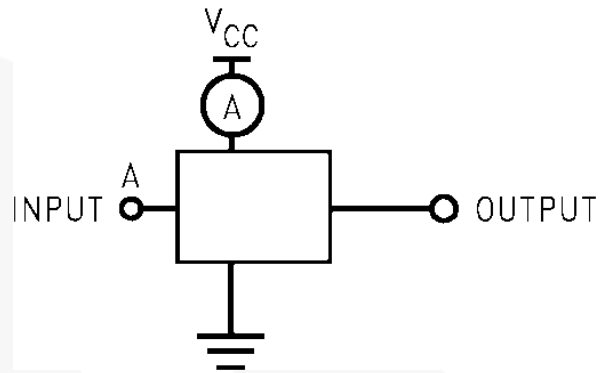


Figure 5. I_{CCD} Test Circuit

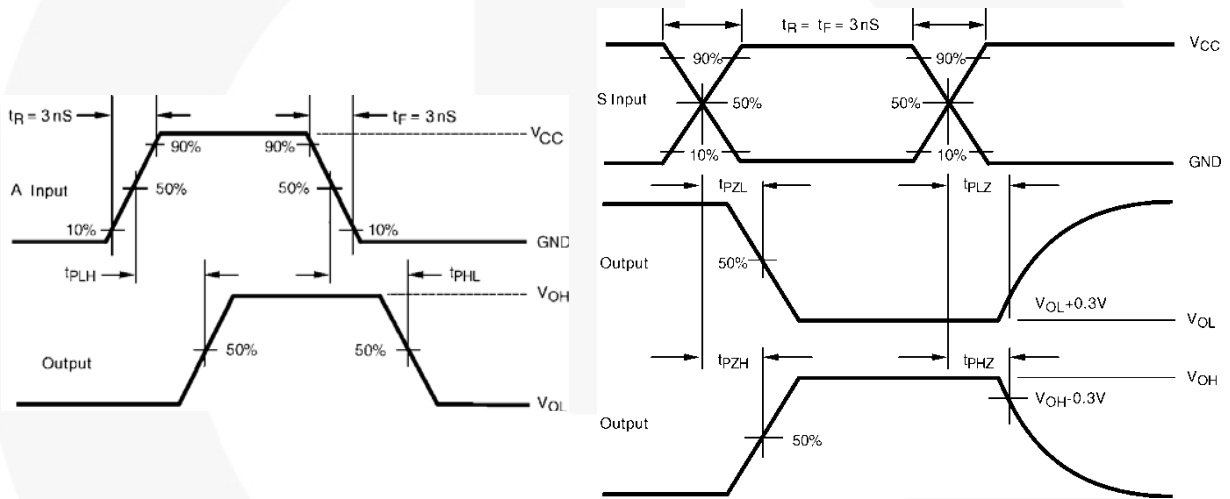


Figure 6. AC Waveforms

Physical Dimensions

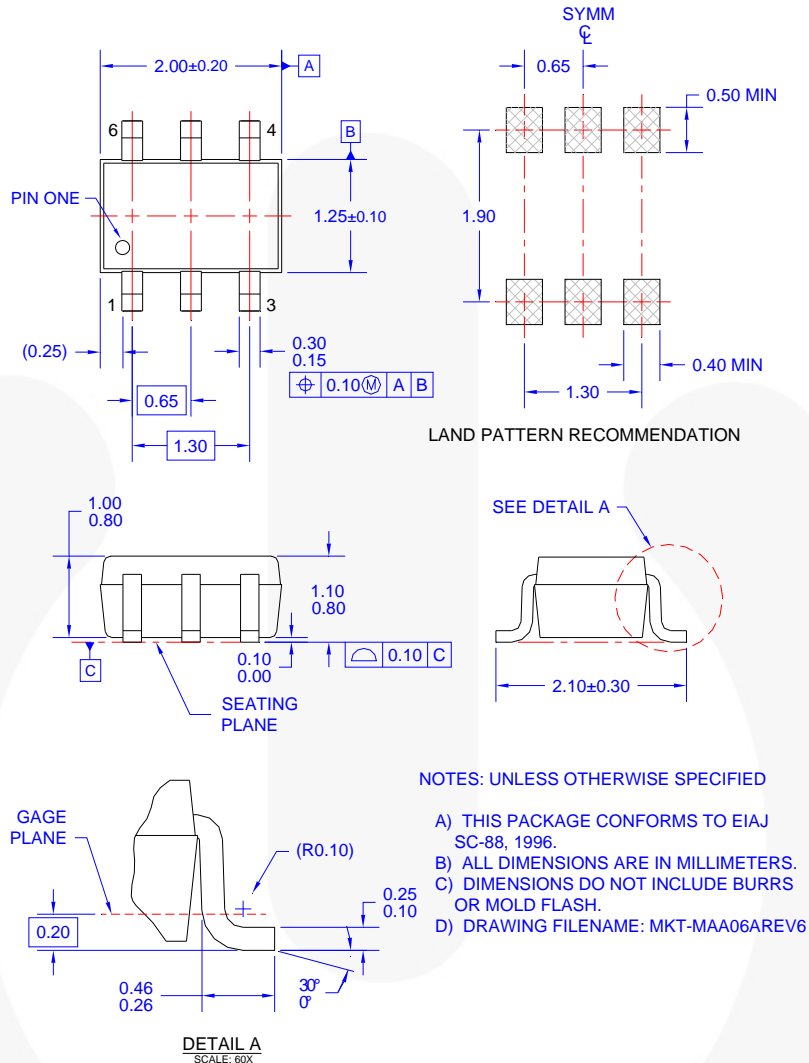


Figure 7. 6-Lead, SC70, EIAJ SC88, 1.25mm Wide

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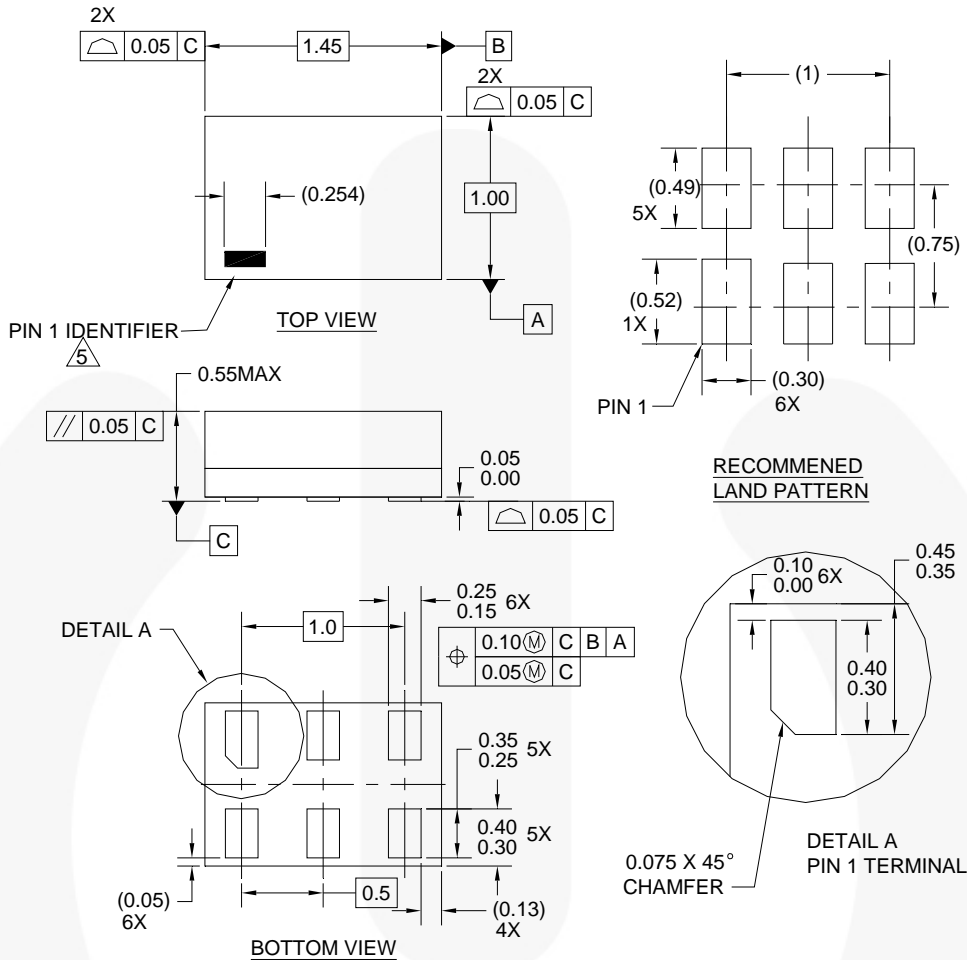
Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings:
<http://www.fairchildsemi.com/packaging/>

Tape and Reel Specification

Please visit Fairchild Semiconductor's online packaging area for the most recent tape and reel specifications:
http://www.fairchildsemi.com/products/analog/pdf/sc70-6_tr.pdf

Package Designator	Tape Section	Cavity Number	Cavity Status	Cover Type Status
P6X	Leader (Start End)	125 (Typical)	Empty	Sealed
	Carrier	3000	Filled	Sealed
	Trailer (Hub End)	75 (Typical)	Empty	Sealed

Physical Dimensions



Notes:

1. CONFORMS TO JEDEC STANDARD M0-252 VARIATION UAAD
2. DIMENSIONS ARE IN MILLIMETERS
3. DRAWING CONFORMS TO ASME Y14.5M-1994
4. FILENAME AND REVISION: MAC06AREV4
5. PIN ONE IDENTIFIER IS 2X LENGTH OF ANY OTHER LINE IN THE MARK CODE LAYOUT.

Figure 8. 6-Lead, MicroPak™, 1.0mm Wide

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Tape and Reel Specification

Please visit Fairchild Semiconductor's online packaging area for the most recent tape and reel specifications:
http://www.fairchildsemi.com/products/logic/pdf/micropak_tr.pdf.

Package Designator	Tape Section	Cavity Number	Cavity Status	Cover Type Status
L6X	Leader (Start End)	125 (Typical)	Empty	Sealed
	Carrier	5000	Filled	Sealed
	Trailer (Hub End)	75 (Typical)	Empty	Sealed

Physical Dimensions

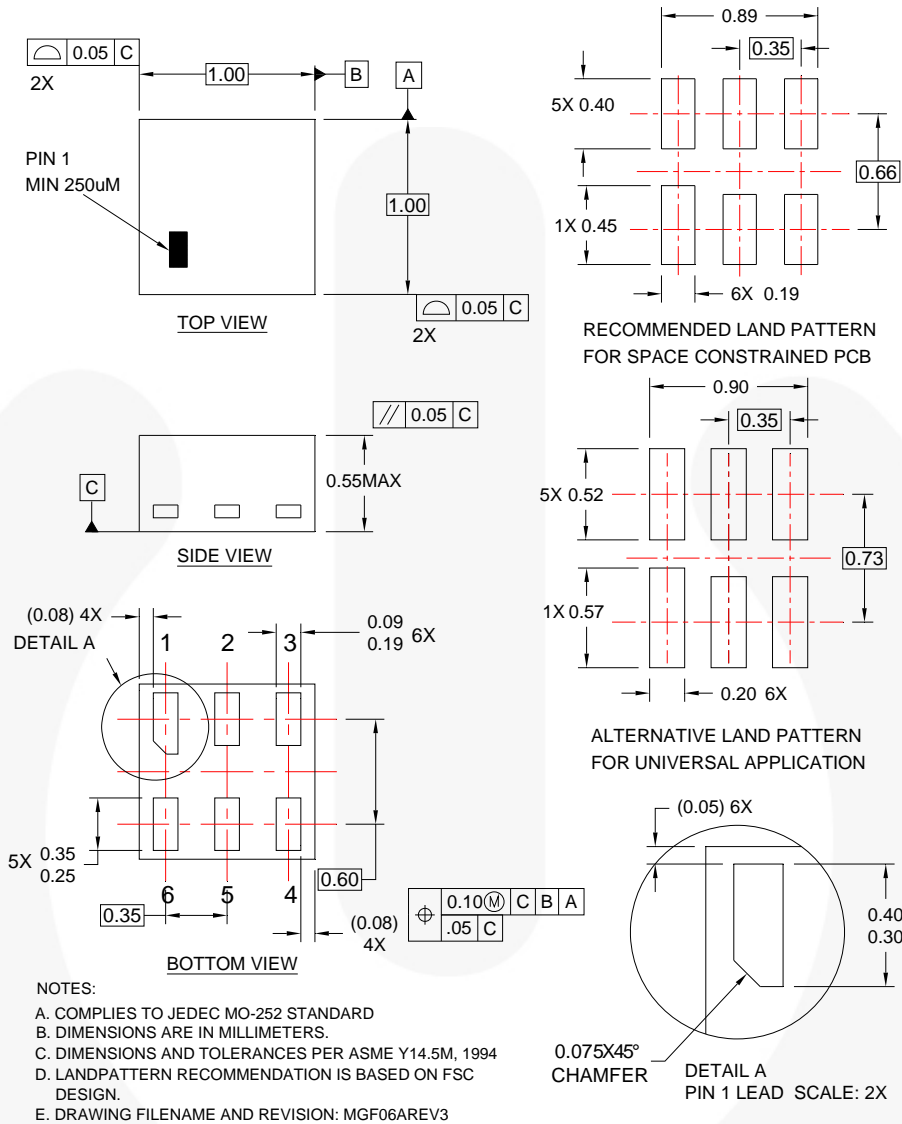


Figure 9. 6-Lead, MicroPak2™, 1x1mm Body, .35mm Pitch

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Tape and Reel Specification

Please visit Fairchild Semiconductor's online packaging area for the most recent tape and reel specifications:
http://www.fairchildsemi.com/packaging/MicroPAK2_6L_tr.pdf.

Package Designator	Tape Section	Cavity Number	Cavity Status	Cover Type Status
FHX	Leader (Start End)	125 (Typical)	Empty	Sealed
	Carrier	5000	Filled	Sealed
	Trailer (Hub End)	75 (Typical)	Empty	Sealed



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| BitSiC® | Global Power Resource™ | Programmable Active Droop™ | TinyBuck™ |
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| Current Transfer Logic™ | ISOPLANAR™ | Saving our world, 1mW/W at a time™ | TinyWire™ |
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Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
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